HI1106

January 1998

NOT RECOMMENDED FOR NEW DESIGNS
See HI1171
or contact our Technical Support Center at
1-888-INTERSIL or www.intersil.com/tsc

8-Bit, 35 MSPS, High Speed D/A Converter (TTL Input)

Features

- **Resolution 8-Bit**
- **High Speed Operation . . . . . 35MHz (Maximum Conversion Speed)**
- **Non-Linearity . . . . . Less Than $\pm 1/2$ LSB**
- **Low Glitch**
- **TTL Compatible Input**
- **Power Supply**
  - **Single . . . . . +5V**
  - **Dual . . . . . ±5V**
- **Low Power Consumption**
  - **+5V Single Power Supply (Typ) 200mW**
  - **±5V Dual Power Supply (Typ) 400mW**
- **Direct Replacement for the Sony CXA1106**

Description

The HI1106 is an 8-bit, 35MHz, high-speed D/A converter IC. Summing type current for the upper 2 bits and ladder type resistance for the lower 6 bits, ensures a low power consumption of 200mW (single power supply).

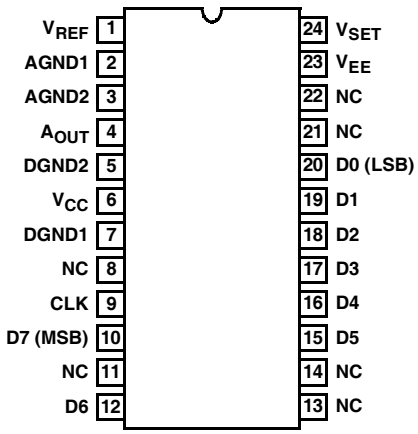
This IC is suitable for digital TVs, graphic displays and other-applications.

Ordering Information

PART NUMBER	TEMP. RANGE (^oC)	PACKAGE	PKG. NO.
HI1106JCB	-20 to 75	24 Ld SOIC	M24.2-S
HI1106JCP	-20 to 75	24 Ld PDIP	E24.4-S

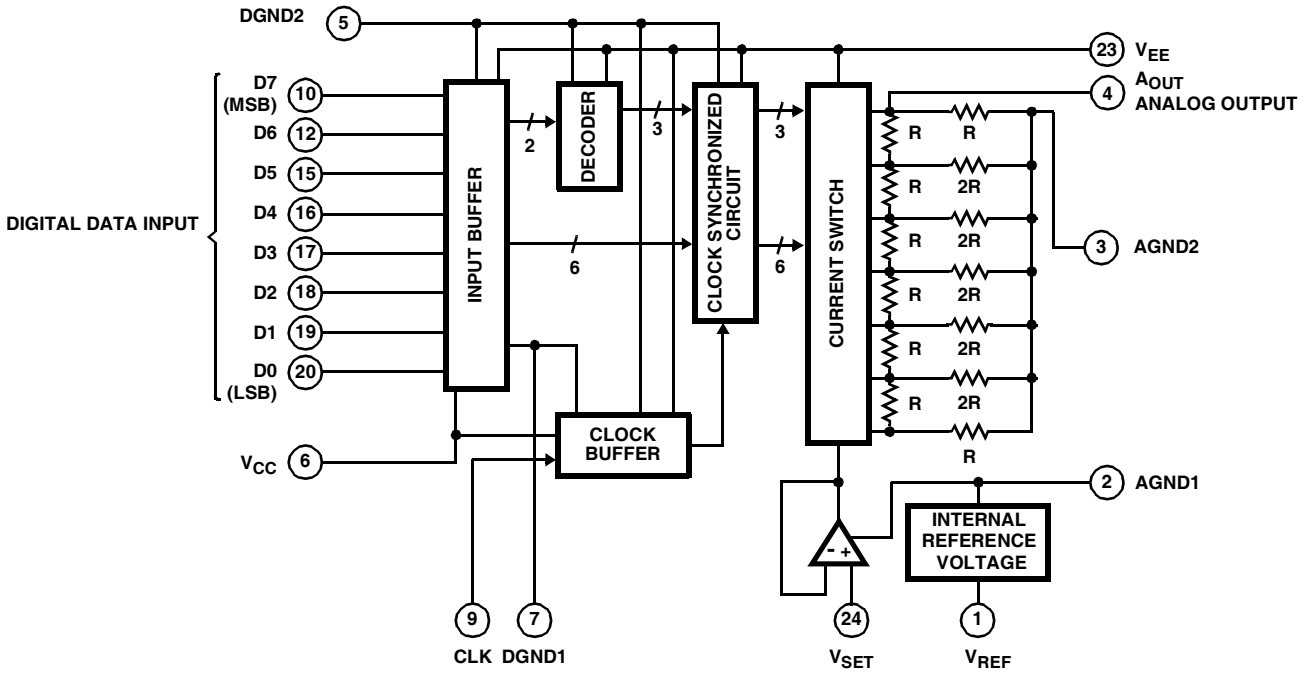
Pinout

HI1106
(PDIP, SOIC)
TOP VIEW

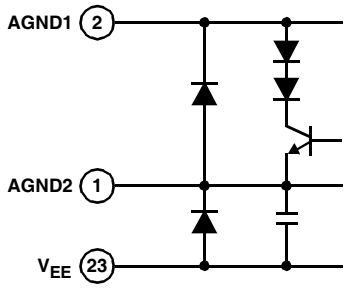
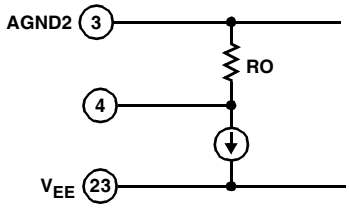


File Number **4113.3**

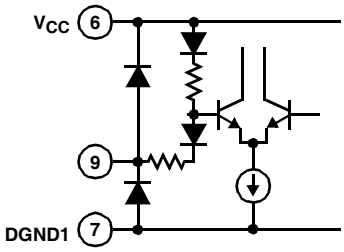
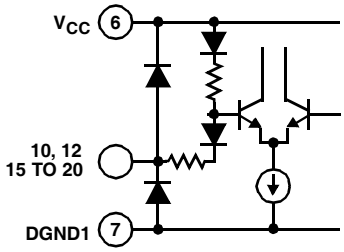
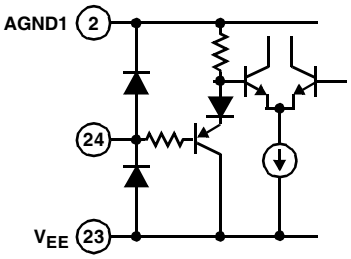
Functional Block Diagram



Pin Descriptions

PIN NO.	SYMBOL	EQUIVALENT CIRCUIT	DESCRIPTION
1	V_{REF}		Internal Reference Voltage Output pin 1.2V (Typ). An external pull down resistance is necessary. For reference see Notes on Application 1.
2	AGND1		Set to Analog V_{CC} for signal power supply and to Analog GND for dual power supply. Connect to AGND2 and use.
3	AGND2		Connect to AGND1.
4	A_{OUT}		Analog Output pin.
5	DGND2		Set to Digital V_{CC} for signal power supply and to Digital GND for dual power supply.
6	V_{CC}		Digital V_{CC}.
7	DGND1		Digital GND.

Pin Descriptions (Continued)

PIN NO.	SYMBOL	EQUIVALENT CIRCUIT	DESCRIPTION
8	NC		No Connect.
9	CLK		Clock Input pin.
10, 12, 15 - 20	D7, D6, D5 - D0		Digital Input pin. D1 to MSB, D8 to LSB
11, 13, 14	NC		No Connect
21, 22	NC		Connect to AGND or V_{EE}.
23	V_{EE}		Set to Analog GND for single power supply and to V_{EE} for dual power supply.
24	V_{SET}		Bias Input pin. Normally set V_{SET} - V_{EE} to 0.84V. For reference see Notes on Application 1.

NOTE: See the Application Circuit for reference.

Absolute Maximum Ratings $T_A = 25^oC$

Supply Voltage
- V_{CC} - $DGND_1$ . . . . . 0V to 6V
- V_{EE} - AGND1, AGND2 . . . . . -6V to 0V
- DGND2 - DGND1 . . . . . 0V to 6V

Digital Input Voltage
- V_I . . . . . DGND1 - 0.3V to V_{CC} + 0.3V
- V_{CLK} . . . . . DGND1 - 0.3V to V_{CC} + 0.3V

Input Voltage (V_{SET} Pin), V_{SET} . . . . . V_{EE} - 0.3V to V_{EE} + 2.7V
Output Current (V_{REF} Pin), I_{REF} . . . . . -5mA to 0mA

Thermal Information

Thermal Resistance (Typical, Note 2)	θ_{JA} ($^oC/W$)
PDIP Package	90
SOIC Package	90

Maximum Power Dissipation, P_D 1.27W
Maximum Junction Temperature (Plastic Package) . . . . . 150^oC
Maximum Storage Temperature Range, T_{STG} . . . . -55^oC to 150^oC
Maximum Lead Temperature (Soldering 10s) . . . . . 300^oC
(SOIC - Lead Tips Only)

Recommended Operating Conditions

SINGLE POWER SUPPLY	MIN	TYP	MAX
Supply Voltage			
V_{CC}, DGND2, AGND1, AGND2	4.75V	5V	5.25V
DGND2 - AGND1, DGND2 - AGND2	-0.2V	0V	0.2V
AGND1 - AGND2	-0.1V	0V	0.1V
Digital Input Voltage			
H Level, V_{IH}, V_{CLKH}	2.0V	-	V_{CC}
L Level, V_{IL}, V_{CLKL}	DGND1	-	1V
V_{SET} Input Voltage, V_{SET}	0.70V	0.84V	1V
V_{REF} Pin Current, I_{REF}	-3.0mA	-	-0.4mA
Clock Pulse Width (Note 1)			
t_{PW1}	10ns	-	-
t_{PW0}	10ns	-	-
Temperature Range, T_{OPR}	-20^oC to 75^oC		

DUAL POWER SUPPLY	MIN	TYP	MAX
Supply Voltage			
V_{CC}	4.75V	5V	5.25V
V_{EE}	-5.5V	5V	-4.75V
DGND2 - AGND1, DGND2 - AGND2	-0.2V	0V	-0.2V
AGND1 - AGND2	-0.1V	0V	0.1V
Digital Input Voltage			
H Level, V_{IH}, V_{CLKH}	2.0V	-	V_{CC}
L Level, V_{IL}, V_{CLKL}	DGND1	-	1V
V_{SET} Input Voltage, V_{SET}	-4.30V	-4.16V	-4.00V
V_{REF} Pin Current, I_{REF}	-3mA	-	-0.4mA
Clock Pulse Width			
t_{PW1}	10ns	-	-
t_{PW0}	10ns	-	-

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

1. See Figure 6 in the Timing Diagram.
2. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

Electrical Specifications $T_A = 25^oC$, V_{CC} = DGND2 = AGND1 = AGND2 = 5V, DGND1 = V_{EE} = 0V, V_{SET} = 0.84V

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SINGLE POWER SUPPLY					
Resolution, n		-	8	-	Bit
Maximum Conversion Speed, f_{MAX}	$R_L > 10k\Omega$, $C_L < 20pF$	35	-	-	MHz
Linearity Error, EL	$R_L > 10k\Omega$	-0.5	-	0.5	LSB
Differential Linearity Error, ED		-0.5	-	0.5	LSB
Full Scale Output Voltage, V_{FS}	$R_L > 10k\Omega$	0.9	1.0	1.1	V
Offset Voltage (Note 2), V_{OS}	$R_L > 10k\Omega$	0	4	10	mV
Output Resistance, R_O		290	350	410	Ω
Power Supply Current, I_{CC}	$R_L > 10k\Omega$, $I_{REF} = -400\mu A$	32	40	48	mA
Digital Input Current					
H Level, I_{IH}		0	-	5	μA
L Level, I_{IL}		-400	-	0	μA
V_{SET} Input Current, I_{SET}		-3	-	0	μA
Internal Reference Output Voltage, V_{REF}	$I_{REF} = -400\mu A$	1.17	1.25	1.33	V
Accuracy Output Voltage Range, V_{OC}	$R_L > 10k\Omega$	0.5	1.0	1.50	V
Set-Up Time, t_S		10	-	-	ns
Hold Time, t_H		2	-	-	ns
Propagation Delay Time, t_{PD}	$R_L > 10k\Omega$	-	11	-	ns
Glitch Energy, GE	$R_L > 10k\Omega$, f_{CLK} = 1MHz, Digital Lamp Output	-	30	-	pV/s

NOTE:

3. V_{OS} = AGND2 - V255 (V255 is the output voltage when full input is at high level).

Electrical Specifications $T_A = 25^oC$, $V_{CC} = 5V$, DGND1 = DGND2 = AGND1 = AGND2 = 0V, $V_{EE} = -5V$, $V_{SET} - V_{EE} = 0.84V$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
DUAL POWER SUPPLY					
Resolution, n		-	8	-	Bit
Maximum Conversion Speed, f_{MAX}	$R_L > 10k\Omega$, $C_L < 20pF$	35	-	-	MHz
Linearity Error, EL	$R_L > 10k\Omega$	-0.5	-	0.5	LSB
Differential Linearity Error, DNL		-0.5	-	0.5	LSB
Full Scale Output Voltage, V_{FS}	$R_L > 10k\Omega$	0.9	1.0	1.1	V
Offset Voltage, V_{OS}	$R_L > 10k\Omega$	0	4	10	mV
Output Resistance, R_O		290	350	410	Ω
Power Supply Current	$R_L > 10k\Omega$, $I_{REF} = -400\mu A$				
I_{CC}		24	30	36	mA
I_{EE}		40	50	60	mA
Digital Input Current					
H Level, I_{IH}		0	-	5	μA
L Level, I_{IL}		-400	-	0	μA
V_{SET} Input Current, I_{SET}		-3	-	0	μA
Internal Reference Output Voltage, V_{REF}	$I_{REF} = -400\mu A$	-3.83	-3.75	-3.67	V
Accuracy Output Voltage Range, V_{OC}	$R_L > 10k\Omega$	0.5	1.0	1.50	V
Set-Up Time, t_S		10	-	-	ns
Hold Time, t_H		2	-	-	ns
Propagation Delay Time, t_{PD}	$R_L > 10k\Omega$	-	11	-	ns
Glitch Energy, GE	$R_L > 10k\Omega$, f_{CLK} = 1MHz Digital Lamp Output	-	30	-	pV/s

INPUT/OUTPUT CODE TABLE
(When Output Full Scale Voltage at 1.00V)

INPUT CODE								OUTPUT VOLTAGE (SINGLE SUPPLY)	OUTPUT VOLTAGE (DUAL SUPPLY)
MSB							LSB		
1	1	1	1	1	1	1	1	V_{CC}	-0V
1	0	0	0	0	0	0	0	V_{CC} -0.5V	-0.5V
0	0	0	0	0	0	0	0	V_{CC} -1V	-1V

Test Circuits

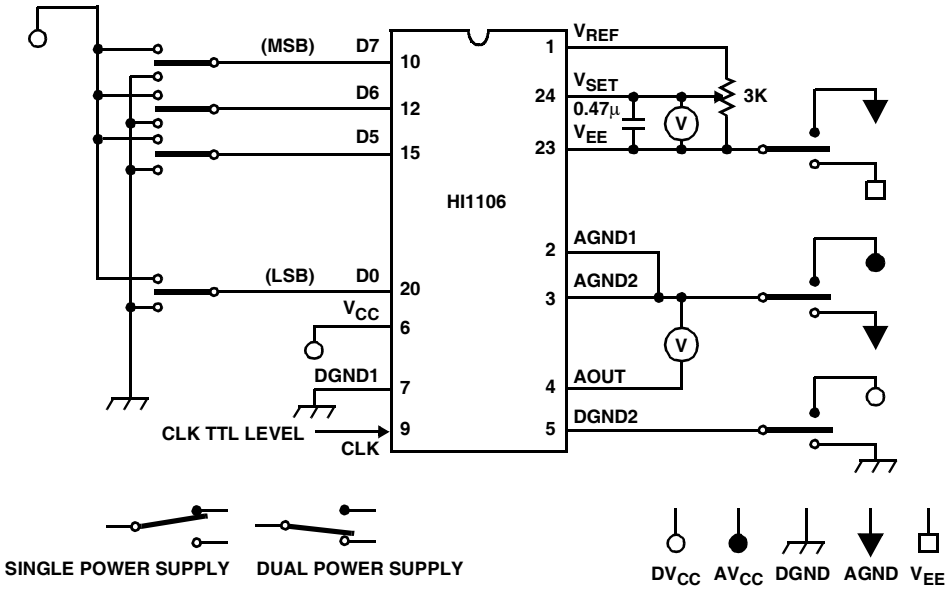


FIGURE 1. DC CHARACTERISTICS

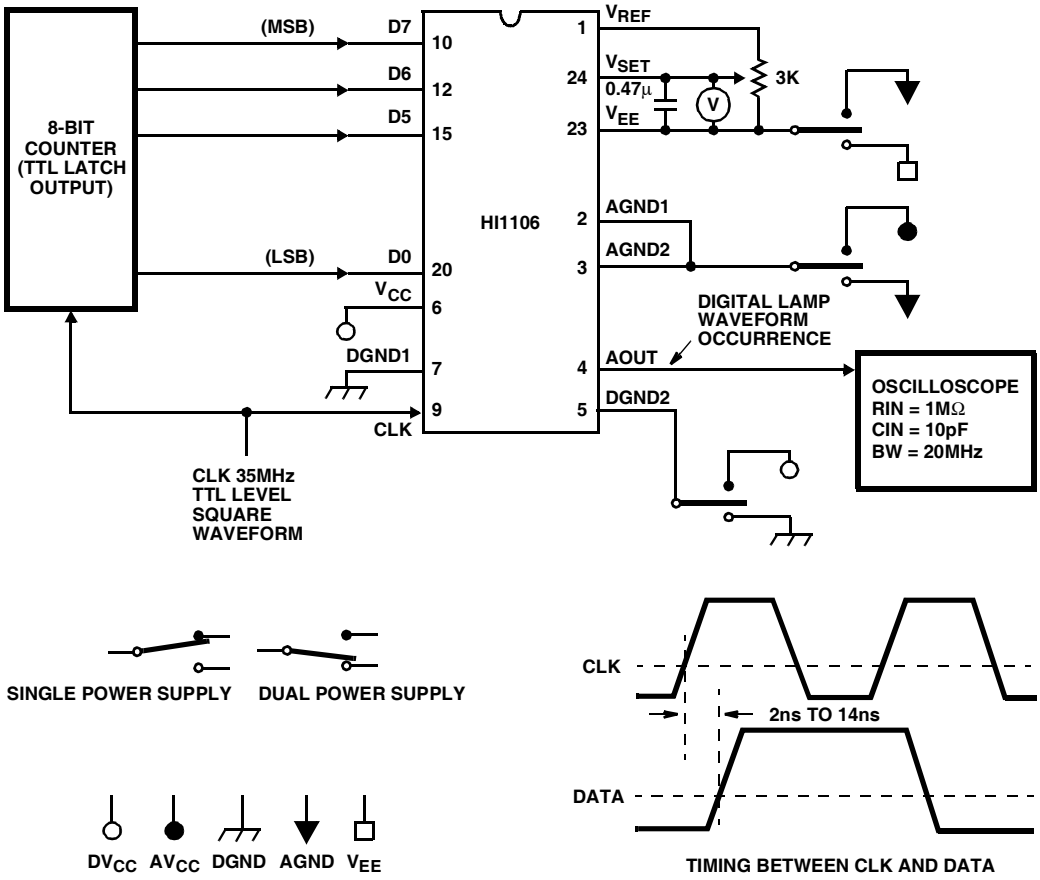


FIGURE 2. MAXIMUM CONVERSION SPEED

Test Circuits (Continued)

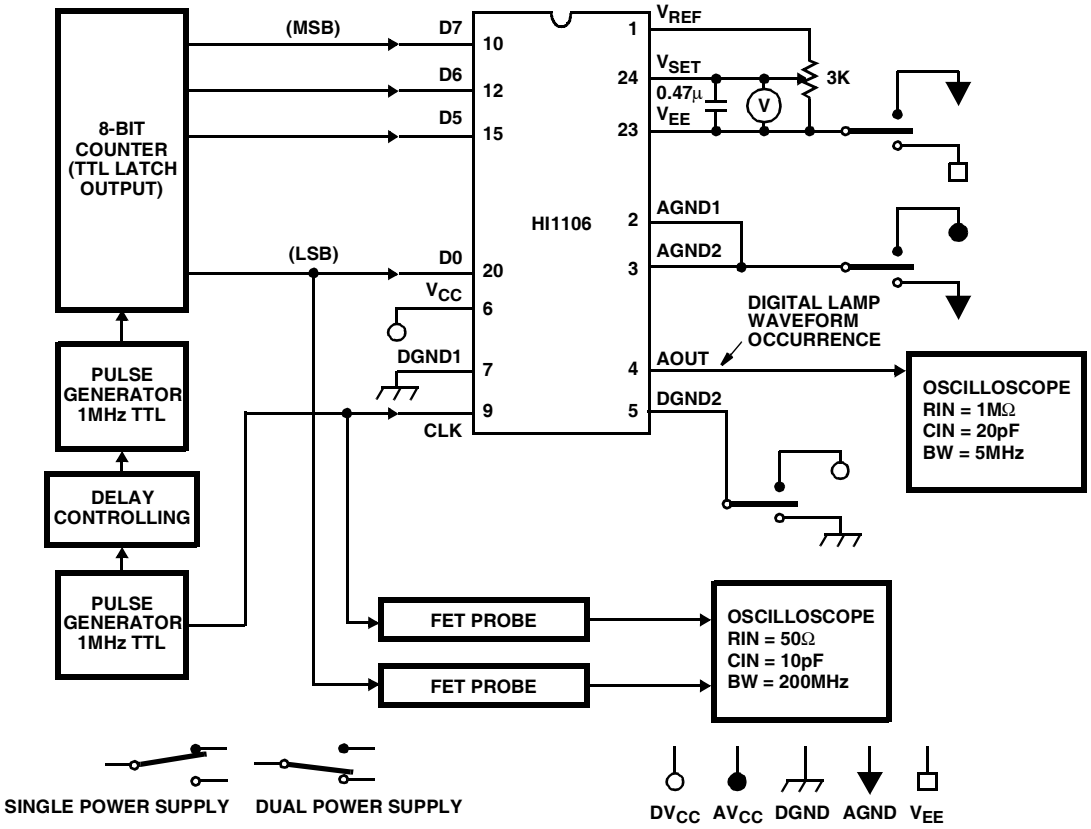


FIGURE 3. SET-UP TIME AND HOLD TIME

Test Circuits (Continued)

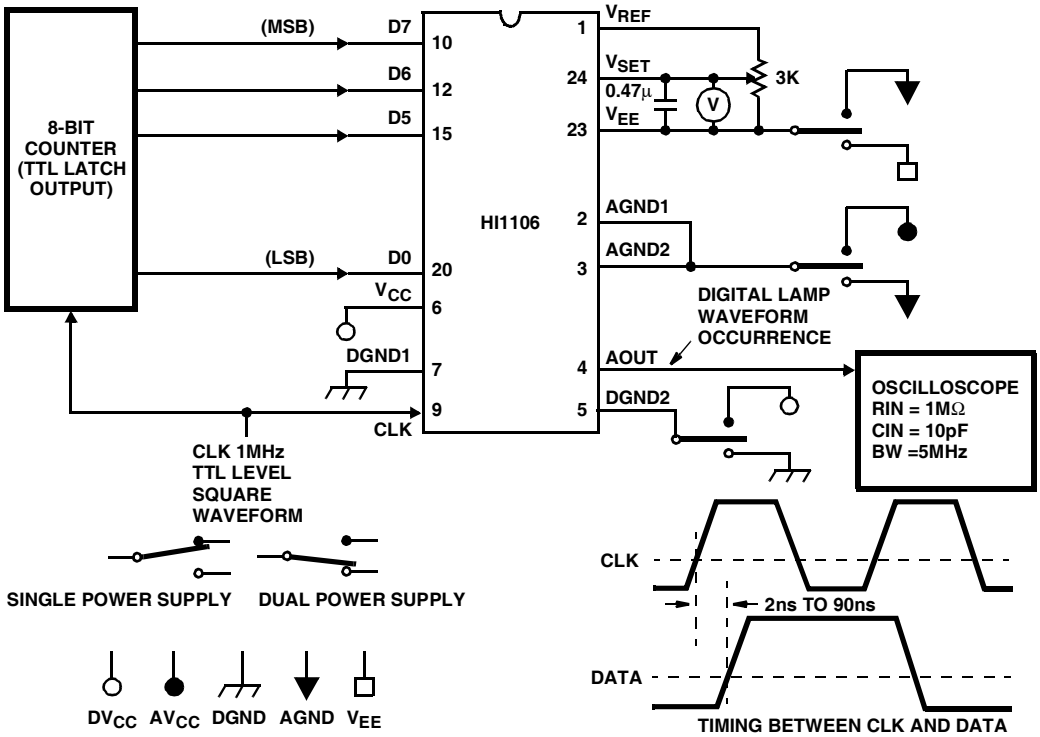


FIGURE 4. GLITCH AREA

Test Circuits (Continued)

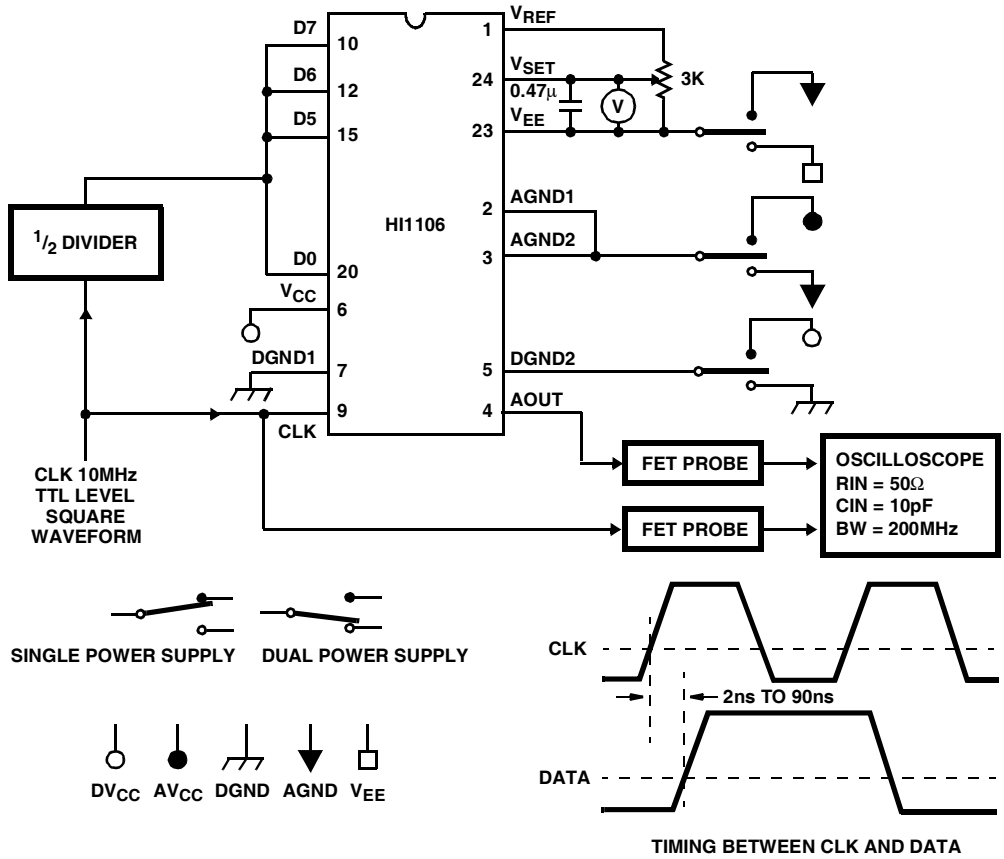


FIGURE 5. PROPAGATION DELAY TIME

Timing Diagram

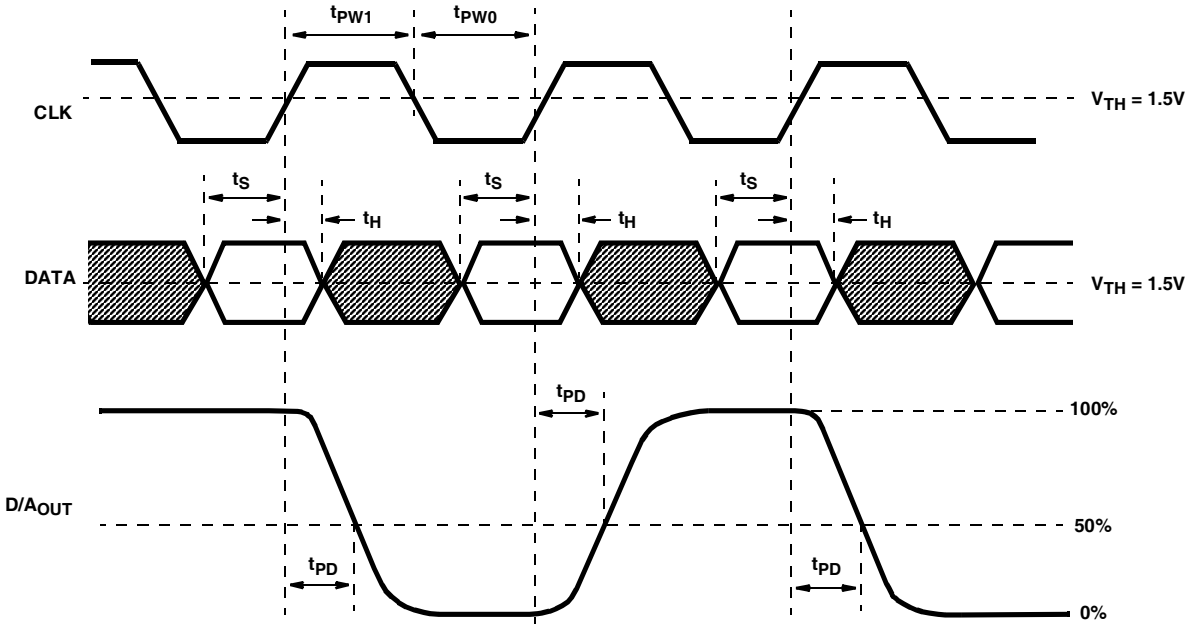


FIGURE 6.

Typical Performance Curves

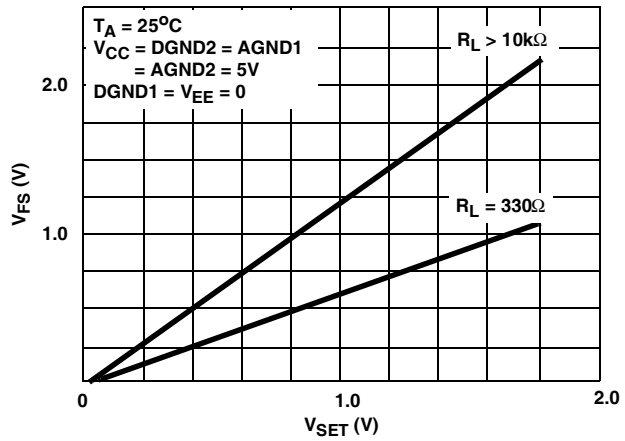


FIGURE 7. FULL-SCALE OUTPUT VOLTAGE (V_{FS}) vs V_{SET} (SINGLE POWER SUPPLY)

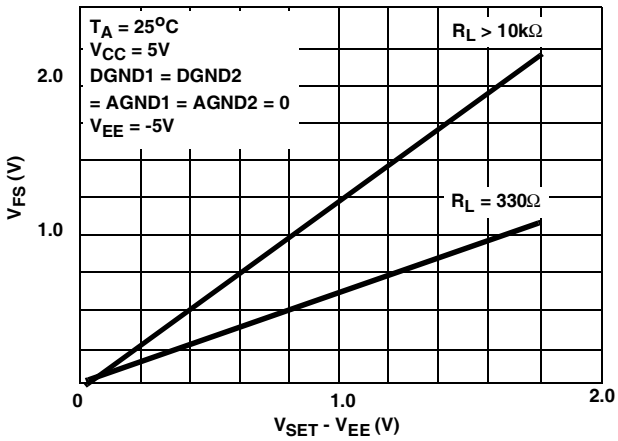


FIGURE 8. FULL-SCALE OUTPUT VOLTAGE (V_{FS}) vs V_{SET} - V_{EE} (DUAL POWER SUPPLY)

Typical Performance Curves (Continued)

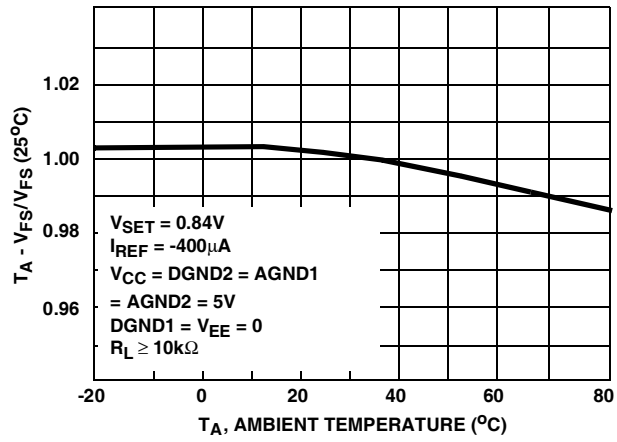


FIGURE 9. FULL-SCALE OUTPUT VOLTAGE (V_{FS}) vs TEMPERATURE (SINGLE POWER SUPPLY)

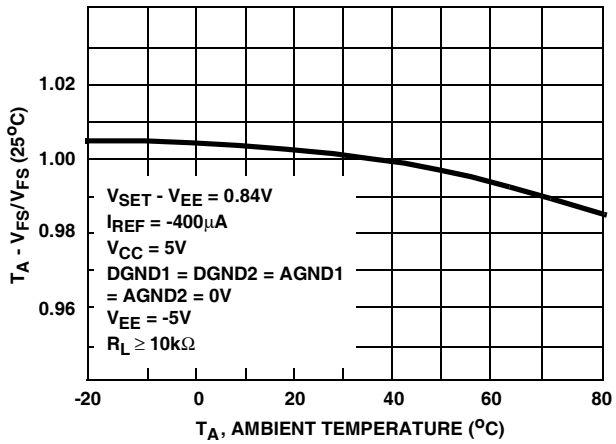


FIGURE 10. FULL-SCALE OUTPUT VOLTAGE (V_{FS}) vs TEMPERATURE (DUAL POWER SUPPLY)

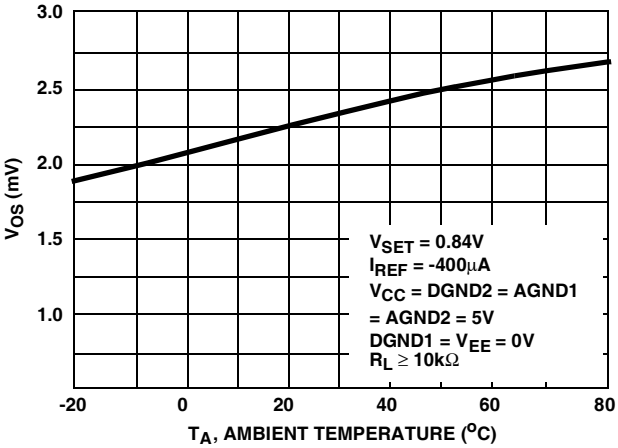


FIGURE 11. OUTPUT OFFSET VOLTAGE (V_{OS}) vs TEMPERATURE (SINGLE POWER SUPPLY)

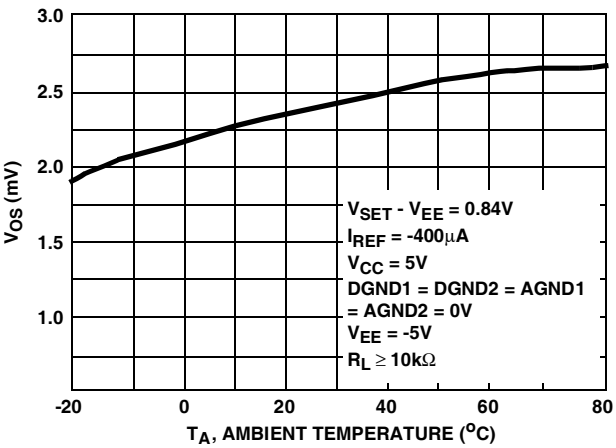


FIGURE 12. OUTPUT OFFSET VOLTAGE (V_{OS}) vs TEMPERATURE (DUAL POWER SUPPLY)

Typical Performance Curves (Continued)

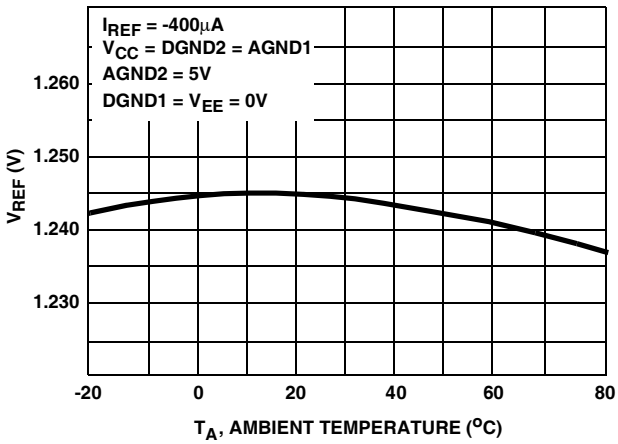


FIGURE 13. INTERNAL REFERENCE VOLTAGE (V_{REF}) vs TEMPERATURE (SINGLE POWER SUPPLY)

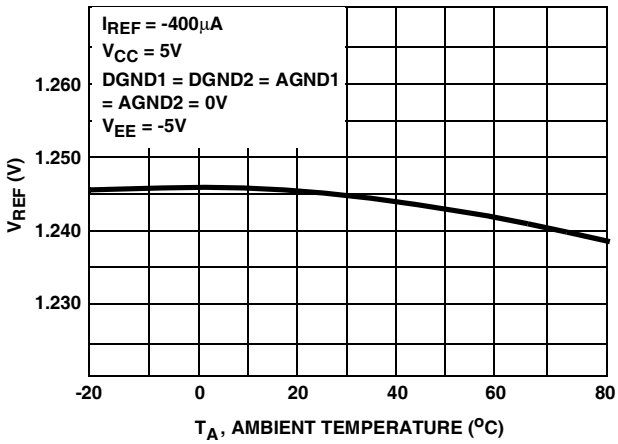


FIGURE 14. INTERNAL REFERENCE VOLTAGE (V_{REF}) vs TEMPERATURE (DUAL POWER SUPPLY)

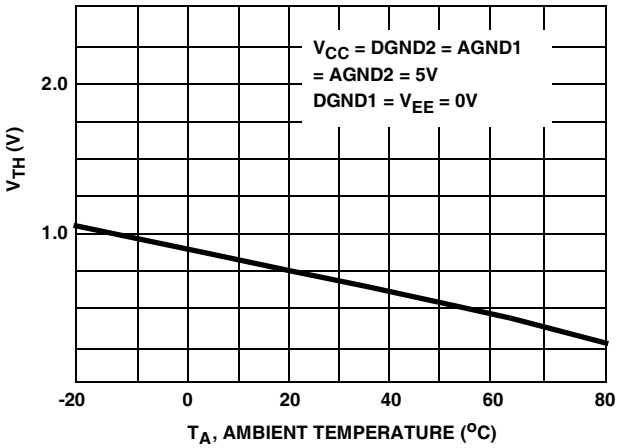


FIGURE 15. THRESHOLD VOLTAGE (V_{TH}) OF DIGITAL INPUT vs TEMPERATURE (SINGLE POWER SUPPLY)

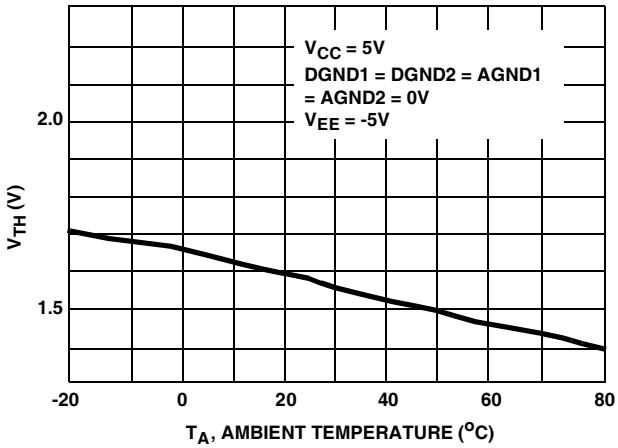


FIGURE 16. THRESHOLD VOLTAGE (V_{TH}) OF DIGITAL INPUT vs TEMPERATURE (DUAL POWER SUPPLY)

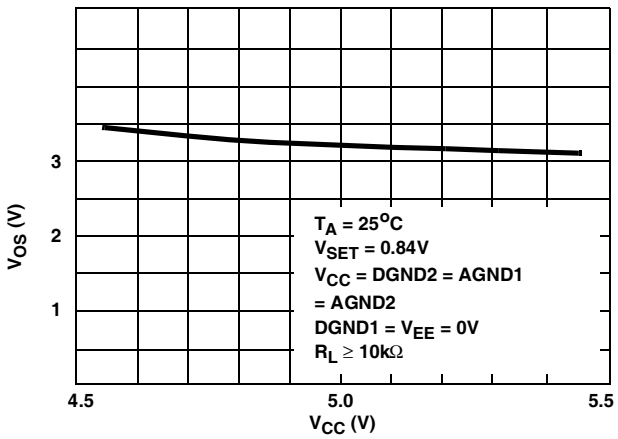


FIGURE 17. OUTPUT OFFSET VOLTAGE (V_{OS}) vs SUPPLY VOLTAGE (SINGLE POWER SUPPLY)

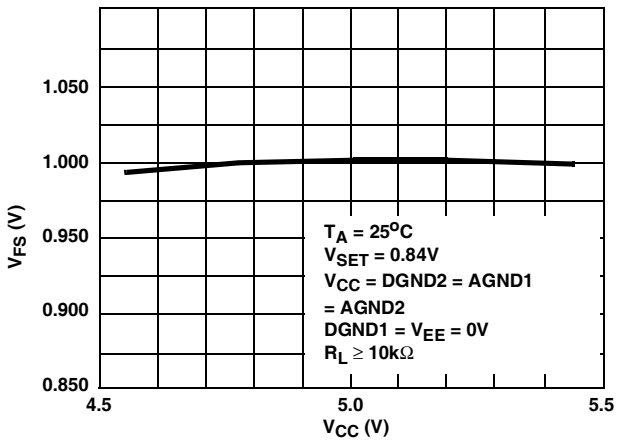


FIGURE 18. OUTPUT FULL-SCALE VOLTAGE (V_{FS}) vs SUPPLY VOLTAGE (DUAL POWER SUPPLY)

Typical Performance Curves (Continued)

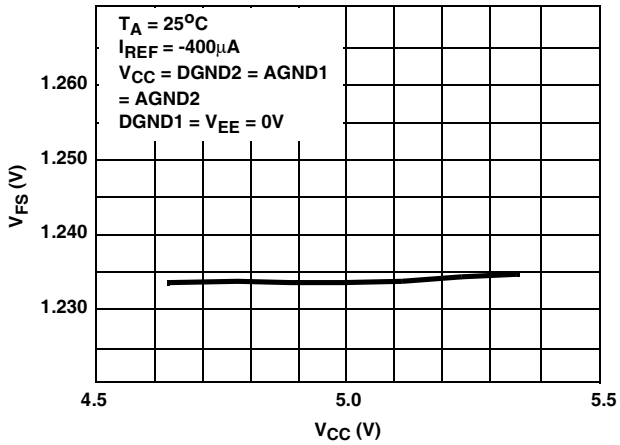


FIGURE 19. INTERNAL REFERENCE VOLTAGE (V_{REF}) vs SUPPLY VOLTAGE (SINGLE POWER SUPPLY)

Application Circuits

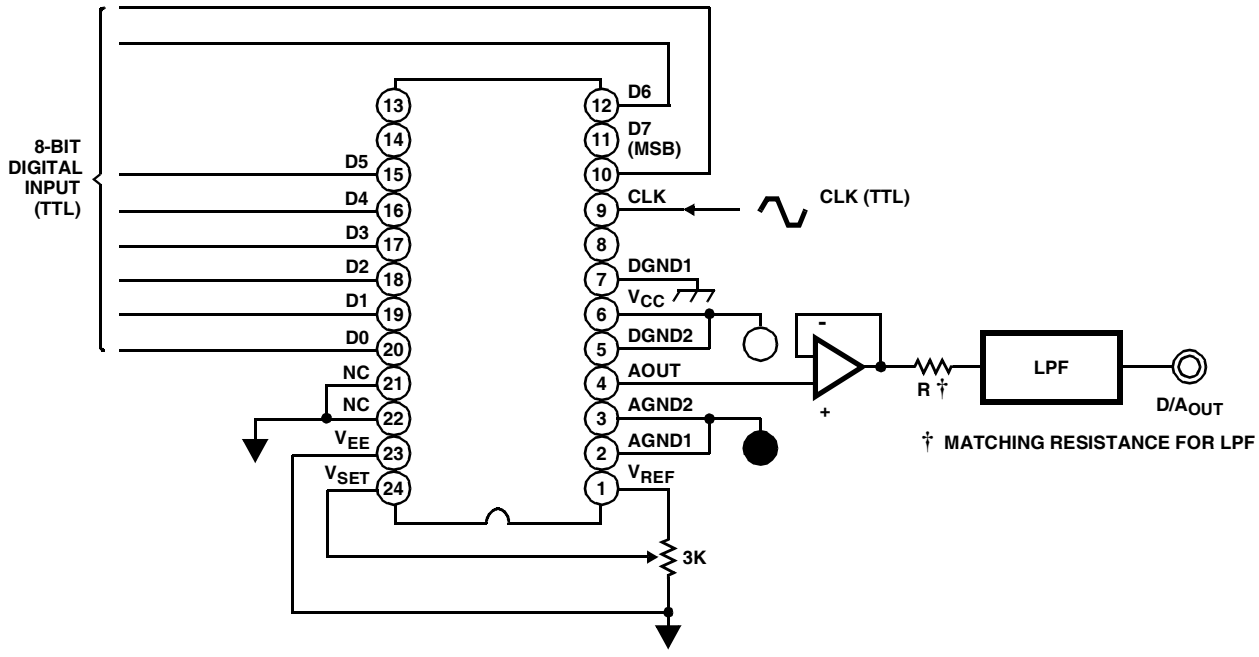


FIGURE 20. SINGLE POWER SUPPLY

Application Circuits

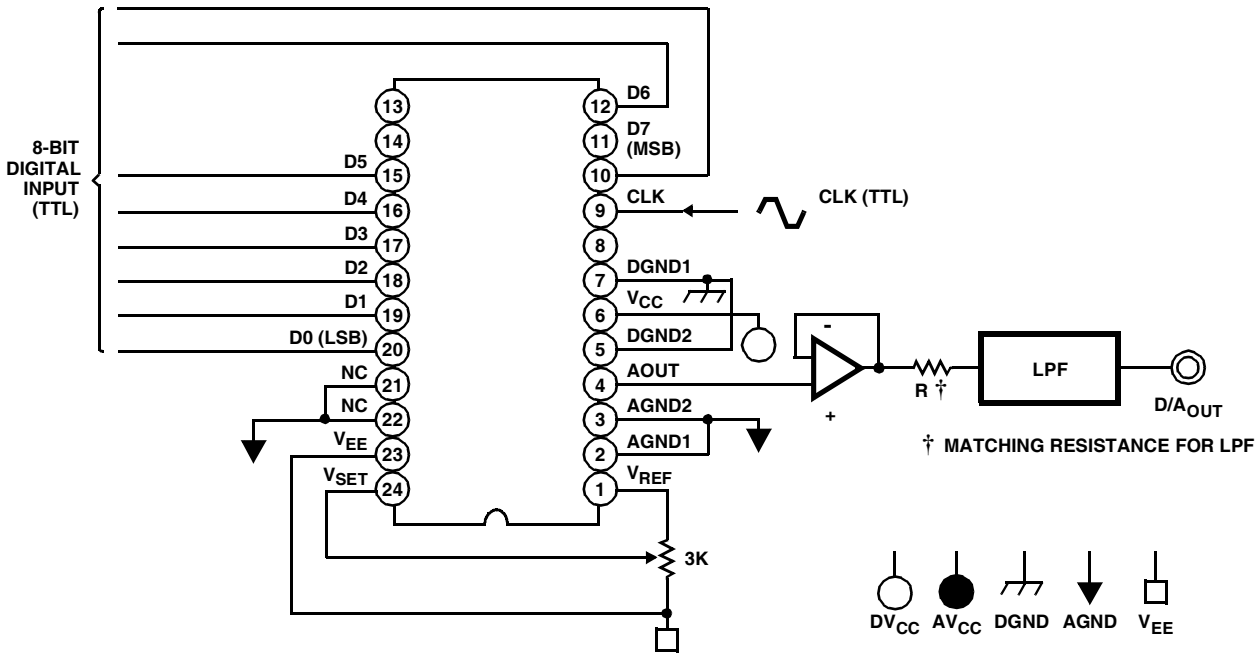


FIGURE 21. DUAL POWER SUPPLY

Notes On Application

1. Setting of V_{REF} Pin (Pin 24)
   The full-scale voltage of the D/A output is determined by V_{SET} input voltage. As about (1.2V - V_{EE}) DC voltage is generated at V_{REF} pin (Pin 1) by connecting an external resistor from V_{REF} pin to V_{EE} pin (Pin 23), divide this voltage using resistors and apply it to V_{SET} pin as Figure 22. Example of usage:

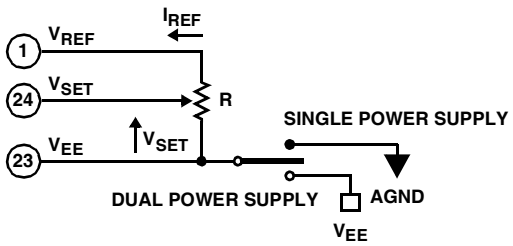


FIGURE 22.

   The full-scale voltage of the D/A output can be determined from the following equation:
   $V_{FS} = 1.2\ (V_{SET} - V_{EE})$ ($R_L > 10k\Omega$, $0.4V \le V_{SET} \le 1.2V$
   Select an external resistor R (connected to V_{REF} pin) so that I_{REF} (current of an external resistor) is within the value indicated as the Recommended Operating Conditions of ($-3mA < I_{REF} < -0.4mA$).

2. Phase Relation Between Data and Clock
   To make the best use of the inherent characteristics of this D/A converter the phase relation between the data and clock applied from the exterior, should be properly set. Set up time (t_S) and Hold time (t_H) should be as indicated in the Electrical Specifications. For t_S and t_H refer to Figure 6 in the Timing Waveform. Also, set the clock pulse width according to the Recommended Operating Conditions.

3. D/A Output Pin Load
   Receive the D/A output stage at high impedance, so as to obtain:
   $R_L > 10k\Omega$,
   $C_L < 20pF$.

4. Noise Reduction
   Refer to the following notes in order to minimize noise contamination that occurs from outside the IC and penatrates D/A output.
   - The power supply line and ground line should be made as wide as possible when fixed to the printed circuit board. Analog and Digital circuits should be separated.
   - Connected a bypass capacitor between each of DV_{CC} (Pin 6) and DGND1 (Pin 7); AGND1, 2 (Pins 2, 3) and V_{EE} (Pin 23); V_{SET} (Pin 24) and V_{EE} (Pin 23), respectively.